# Proximity effect at superconducting Sn-Bi<sub>2</sub>Se<sub>3</sub> interface

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We have investigated the conductance spectra of Sn-Bi<sub>2</sub>Se<sub>3</sub> interface junctions down to 250 mK and in different magnetic fields. A number of conductance anomalies were observed below the superconducting transition temperature of Sn, including a small gap that is different from that of Sn, and a zero-bias conductance peak that increases at lower temperatures. We discussed the possible origins of the smaller gap and the zero-bias conductance peak. These phenomena support the idea that a proximity-effect-induced chiral superconducting phase is formed at the interface between the superconducting Sn and the strong spin-orbit coupling material  $Bi_2Se_3$ .

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#### I. INTRODUCTION

Due to strong spin-orbit coupling (SOC), electrons in the surface states (SSs) of a topological insulator (TI) become completely helical, forming a different category of half metals.<sup>1-3</sup> Among many exciting features of TIs, the exotic physics at the interface between a three-dimensional (3D) TI and an s-wave superconductor is of particular interest. According to theoretical predictions, unconventional superconductivity with effectively spinless  $p_x + ip_y$  pairing symmetry will be induced via the proximity effect, and Majorana bound states will emerge at the edges.<sup>4–8</sup> Several experimental schemes have been proposed to test the predictions, but the progress reported so far has been limited to the observations of a supercurrent in Al-Bi<sub>2</sub>Se<sub>3</sub>-Al junctions.<sup>9</sup> It is not clear whether this is because the predicted exotic properties are suppressed by the existence of bulk states (BSs) which are present in most transport measurements. Nevertheless, there are signs that the majority electrons are still significantly helical in the presence of BSs. For example, the magnetoresistance of Bi2Se3 exhibits an unusually robust weak antilocalization behavior,<sup>10-14</sup> indicating the existence of a Berry phase  $\pi$  in the band structure of those electrons involved in transport measurements. Therefore, it is possible that some of the unique properties originally predicted for ideal TIs are still experimentally observable even in the presence of BSs.

In this paper, we report our experimental investigation on the conductance spectra of superconductor-normal metal (S-N) interface junctions made of Sn film and Bi<sub>2</sub>Se<sub>3</sub> singlecrystalline flakes with BSs, where Sn is a simple *s*-wave superconductor, and Bi<sub>2</sub>Se<sub>3</sub> is a typical 3D TI candidate.<sup>15</sup> Several anomalies were found, including a double-gap structure that develops below the superconducting transition temperature of Sn and a zero-bias conductance peak that increases at lower temperatures. We will discuss the possible origins of these phenomena, and to show that they can be interpreted by the formation of a proximity-effect-induced chiral superconducting phase at the interface.

### II. EXPERIMENT: Sn-Bi<sub>2</sub>Se<sub>3</sub> JUNCTIONS

The Bi<sub>2</sub>Se<sub>3</sub> flakes used in this experiment were mechanically exfoliated from a high-quality single crystal, and those with thickness of ~100 nm were transferred to degenerate-doped Si substrates with a 300-nm-thick SiO<sub>2</sub> for device fabrication. Two Pd electrodes were first deposited onto a selected flake. Then, an insulating layer of heavily overexposed poly(methyl methacrylate) (PMMA) photoresist with a  $1 \times 1 \mu m^2$  hole at the center was fabricated on top of the flake. Finally, 200-nm-thick Sn electrodes were patterned and deposited via sputtering. The device structure and measurement configuration are illustrated in Figs. 1(b) and 1(c). A pseudo-four-terminal measurement was performed in a <sup>3</sup>He cryostat by using lock-in amplifiers, with an ac excitation current of 1  $\mu$ A at 30.9 Hz.

Determined from Hall effect measurements, the thin flakes of Bi<sub>2</sub>Se<sub>3</sub> used in this experiment have a typical carrier density of  $10^{18}$  cm<sup>-3</sup> and a typical mobility of 5000 cm<sup>2</sup>/V s at T = 1.6 K. The Sn films deposited show a sharp superconducting transition at  $T_c \approx 3.8$  K and with a critical field  $H_c$  of less than 60 mT at 300 mK, indicating their high quality in terms of superconductivity, in spite of the granular morphology [Fig. 1(c)] due to self-annealing at room temperature.

For the study of the proximity effect, a clean interface and a relatively small junction resistance are necessary. If the interfacial barrier strength is too high, no proximity effect will occur. In order to improve the contact between Sn and Bi<sub>2</sub>Se<sub>3</sub>, some of the devices were treated with Ar-ion etching in a reactive-ion-etching system, to remove the possible remnant photoresist in the junction area prior to Sn deposition (with a pressure of 100 mTorr, a power of 50 W, and for ~10 s). Since Ar does not react with Bi<sub>2</sub>Se<sub>3</sub>, the etching is generally a physical process. Ar etching is found to be helpful to enhance the transparency of the junction. But good contact can still be achieved without etching. The primary features of the conductance spectra were found to be similar for devices with comparable interfacial resistance, regardless of the treatment prior to Sn deposition.



FIG. 1. (Color online) (a) Temperature dependencies of zerobias conductance of Sn-Bi<sub>2</sub>Se<sub>3</sub> junction devices #1 and #2. The temperature is normalized to the superconducting transition point of the Sn film,  $T_c \approx 3.8$  K, and the conductance is normalized to its value just above  $T_c$ . The solid lines represent the tendency of saturation expected from Blonder-Tinkham-Klapwijk (BTK) theory for *s*-wave S-N junctions with a medium interfacial scattering strength (Ref. 16). A magnetic field of 0.1 T completely suppressed all the features below  $T_c$ . The white and blue (light gray) regions correspond to the two stages of proximity effect discussed in the text. (b) Illustrations of the device structure. (c) Optical image of the device and measurement configuration.

More than a dozen devices were fabricated and measured at T = 1.6 K, and six of them were further investigated down to 250 mK. All devices exhibited qualitatively similar features. In this paper, we show the data taken from three typical devices, labeled as #1, #2, and #3. The normal-state resistance (taken at T = 4 K) of these devices are 13.5, 7.5, and 10.2  $\Omega$ , respectively.

Figure 1(a) shows the measured zero-bias differential conductance *G* as a function of *T* for devices #1 and #2, where the data are normalized to their values above  $T_c \approx 3.8$  K. With decreasing *T*, the conductance increases abruptly below  $T_c$ , reaches a peak with a maximum enhancement of 3.9% for device #1 and 7.7% for device #2, and then the conductance drops gradually until a turning point ~1.2 K. Below this temperature, the conductance increases and deviating from the saturation tendency expected from the Blonder-Tinkham-Klapwijk (BTK) theory.<sup>16</sup> The deviation at 250 mK is ~8% for device #1 and ~3% for device #2. By applying a magnetic field B = 0.1 T, all the low-temperature structures on the *G-T* curves were removed, indicating that they are closely related to the superconductivity of Sn.

In BTK theory,<sup>16</sup> the normalized zero-bias dI/dV of an S-N junction, Y, can be written as

$$Y(Z,T) = \frac{I_{NS}(Z,T)}{I_{NN}(Z)} \bigg|_{eV \to 0}$$
  
=  $(1 + Z^2) \int_{-\infty}^{\infty} \left(\frac{\partial f_0}{\partial E}\right) [2A(E) + C(E) + D(E)],$ 



FIG. 2. (Color online) (a) Conductance spectra of device #1 at different temperatures. Each curve is normalized to its highbias value, and is shifted vertically for clarity. (b) Temperature dependencies of the positions of the dip, the first gap  $\Delta_1$ , and the second gap  $\Delta_2$ . (c) Temperature dependence of the peak height. The peak increases at a temperature that is significantly lower than the  $T_c$  of Sn. (d) Temperature dependence of the full width of the peak at half height.

where the dimensionless parameter Z describes the barrier strength of the S-N junction,  $f_0(E,T)$  is the Fermi distribution, and A(E), C(E), and D(E) are functions defined in the BTK theory. At T = 0 this equation can be simplified to

$$Y|_{T=0} = \frac{2(1+Z^2)}{(1+2Z^2)^2}.$$

With this formula, one can estimate the Z value of a device using its saturated conductance at low temperatures.

In Fig. 1(a), the normalized dI/dV for devices #1 and #2 saturate to about 0.82 and 1.04, as indicated by the solid lines, which yield barrier strengths of Z = 0.66 and 0.54 for devices #1 and #2, respectively. Such barriers are not in the transparent limit (i.e., Z = 0) nor in the tunneling limit ( $Z \gg 1$ ), which ensures the occurrence of a reasonably strong proximity effect at the interface on the one hand, and enabling us to probe the information of the density of states on the other hand.

In Figs. 2 and 3 we show the conductance spectra, namely, the bias voltage ( $V_{\text{bias}}$ ) dependence of differential conductance, of device #1 measured at different temperatures and in different magnetic fields. Each curve is normalized to its high-bias value in region III. Three unusual features were observed, as discussed below.

The first feature is a bumplike enhancement, together with sharp dips at the two sides. It develops at temperatures immediately below  $T_c$  in regions I and II, as marked in Fig. 2, and is best seen at high T when the gaps are largely undeveloped. It corresponds to the abrupt increase of



FIG. 3. (Color online) (a) Conductance spectra of device #1 taken at 300 mK and in different magnetic fields. The curves have been shifted vertically for clarity. (b) Field dependencies of the positions of the dip, the first gap  $\Delta_1$ , and the second gap  $\Delta_2$ . (c) Field dependence of the peak height. (d) Field dependence of the full width of the peak at half height.

conductance in the G-T curves just below  $T_c$ . With decreasing T the bump structure evolves and extends to a bias voltage that is several times larger than the superconducting gap of Sn. In the meantime, gap structures develop around zero-bias voltage, which will be discussed later.

The position of the dips is device dependent. It is very close to zero-bias voltage at temperatures just below  $T_c$ , but can reach as high as 8 mV at low temperatures for high-resistance junctions in this experiment (data not shown). The dips can be safely attributed to current-driven destruction of superconductivity in the local Sn film surrounding the junction. We note that the use of a large measurement current (up to 200  $\mu$ A here) is unavoidable in proximity effect studies where the junctions usually need to be reasonably transparent. Estimation shows that the local current density at the step edge of the window of our junctions could reach  $\sim 10^4 - 10^5 \text{ A/cm}^2$ at  $V_{\text{bias}} = 2 \text{ mV}$  (for a 10- $\Omega$  junction), which may well exceed the critical current density of the Sn film. The nonmonotonic T dependence of the dip position, as shown in Fig. 2, in Fig. 4 for devices #1 and #3, and in Fig. 7 for comparative Sngraphite devices, suggests that the detailed destruction process might involve local heating and thermal conduction which has a significant temperature dependence below  $\sim 1$  K (see Sec. III).

The second feature in the conductance spectra is a doublegap structure that develops on the enhanced conductance background, as shown in region I of Fig. 2(a). The borders of the two gaps are indicated by the arrows. The development of this structure is responsible for the drop in the G-T curves below the peak temperatures in Fig. 1(a). For device #1, the





FIG. 4. (Color online) (a) Conductance spectra of device #3 taken in zero magnetic field and at different temperatures. The blue arrows indicate where the coherence peak of the bigger gap  $\Delta_1$  is expected. Only a faint structure at this position can be resolved (which is best seen on the 1.2-K curve). The curves have been shifted vertically for clarity. (b) Temperature dependence of the peak height at zerobias voltage. (c) Temperature dependence of the full width of the peak at half height. (d) Conductance spectra of device #2 at different temperatures. The curves are shifted vertically for clarity.

first (larger) gap is  $\Delta_1 = 0.59$  mV, which matches with the superconducting gap of Sn, and the second (smaller) gap is  $\Delta_2 = 0.21$  mV, which is only about 1/3 of the first one. It should be noted that for most devices (ten out of 12) only the smaller gap was clearly observed. In Figs. 4(a) and 4(d) we show two such examples observed on devices #3 and #2, respectively. For device #3, a faint structure can still be resolved at the  $\Delta_1$  position, as indicated by the blue arrows in Fig. 4(a), and is best seen on the curve taken at 1.2 K.

The existence of two distinct gaps clearly indicates that the smaller gap is not the superconducting gap of Sn. It should arise from some different superconducting phase formed at the interface, which will be further discussed later.

The third feature in the conductance spectra is a zero-bias conductance peak (ZBCP) developed at low temperatures. This ZBCP is responsible for the conductance increment on *G*-*T* curves below ~1.2 K. The peak height increases almost linearly with decreasing *T*. It reaches 13.4 and 16.4% of the normal-state conductance at the lowest temperature of this experiment, 250 mK, for devices #1 and #3, respectively, as shown in Figs. 2(c) and 4(b). Also, the peak width<sup>17</sup> decreases with decreasing *T* at low temperatures, as shown in Figs. 2(d) and 4(c). Both the height and the width of the ZBCP can be suppressed by applying a magnetic field, as shown in Figs. 3(c) and 3(d).

The temperature dependence of the peak width contains important information about the origin of the ZBCP. When we plot the ZBCP against bias current instead of bias voltage, as



FIG. 5. (Color online) Normalized dI/dV plotted against bias current for devices #1 (a) and #3 (b). (c) Temperature dependence of the full width of the peak at half height, for both devices #1 and #3.

shown in Figs. 5(a) and 5(b) for devices #1 and #3, respectively, the peak width decreases with decreasing *T* as well [Fig. 5(c)]. It indicates that the ZBCP has originated from some kind of resonance whose width is controlled by thermal broadening.

# III. COMPARATIVE EXPERIMENT: Sn-GRAPHITE JUNCTIONS

In order to examine whether the conductance anomalies observed in Sn-Bi<sub>2</sub>Se<sub>3</sub> interfacial junctions are intrinsic properties of the interface between an *s*-wave superconductor Sn and a helical metal, we have made two more devices for comparison by replacing Bi<sub>2</sub>Se<sub>3</sub> with bulk graphite, while keeping the other parameters the same. We choose graphite because it is similar to Bi<sub>2</sub>Se<sub>3</sub> in carrier density and mobility, but with much weaker spin-orbit coupling strength.<sup>18</sup> The two devices, made of graphite flakes of thickness ~100 nm, are labeled as S1 and S2, respectively. Their optical images are shown in Fig. 6.

In Fig. 7(d) we show the measured zero-bias differential conductance G as a function of temperature for these two devices. The data are normalized to their values above  $T_c \approx 3.8$  K (around 6  $\Omega$  for both devices). The G-T curves are similar to that of the Sn-Bi<sub>2</sub>Se<sub>3</sub> devices, except that there is no upturn below ~1.2 K. The conductance decreases with decreasing temperature monotonously down to 250 mK without saturation.

Figures 7(b) and 7(c) show the conductance spectra of devices S1 and S2, respectively, taken at different temperatures. A single gap is developed at low temperatures. The coherence







FIG. 7. (Color online) Conductance spectra of Sn-graphite devices S1 (a) and S2 (b) taken at different temperatures. The curves are shifted vertically for clarity. (c) Temperature dependencies of the dip positions. (d) Normalized zero bias dI/dV as a function of temperature.

peak of that gap is located at  $\sim 0.5$  mV, which is close to the superconducting gap of the Sn electrode. Neither a zero-bias peak nor a second smaller gap was observed. This single-gap structure can be well understood within the BTK theory.

There is a sharp dip at each side of the conductance spectrum, beyond which the curve becomes flat and featureless. As discussed in Sec. II, we attribute the dip structure to the local destruction of superconductivity of the Sn film near the junction. The fact that similar dips were found in both Sn-Bi<sub>2</sub>Se<sub>3</sub> and Sn-graphite junctions suggests that these dips are not specifically related to Bi<sub>2</sub>Se<sub>3</sub>.

The magnetic field dependencies of the conductance spectra of devices S1 and S2 are plotted in Figs. 8(a) and 8(b), respectively. All the structures in the spectrum can be removed by applying a magnetic field higher than the  $H_c$  of Sn, indicating that they are related to the superconductivity of the Sn electrode.

In summary, our comparative experiment on Sn-graphite devices reveals only a single-gapped structure; neither a second smaller gap nor a ZBCP was observable, unlike those on Sn- $Bi_2Se_3$  devices. The data also show that the nonmonotonous temperature dependence of the dip position is irrelevant to the use of  $Bi_2Se_3$ .

## IV. DISCUSSION: POSSIBLE ORIGINS OF THE ZBCP AND THE DOUBLE-GAP STRUCTURE

The general trends of the G-T and G- $V_{\text{bias}}$  curves of the Sn-Bi<sub>2</sub>Se<sub>3</sub> devices can be understood within the framework of the BTK theory,<sup>16</sup> which was developed in the early 1980's to



FIG. 8. (Color online) Conductance spectra of Sn-graphite devices S1 (a) and S2 (b) taken at 250 mK and in different magnetic fields. Curves are shifted vertically for clarity.

describe the two-particle process at S-N interfaces. However, this theory cannot explain the appearance of a second gap, nor the ZBCP at low temperatures.

Previously, ZBCPs were also observed in some S-N (Refs. 19–23) and S-insulator-N (Ref. 24) junctions, and were explained in several different mechanisms.

The first possible mechanism is related to incoherent accumulation of Andreev reflections (ARs), which happens when there is a large probability of backscattering due to, e.g, the involvement of the other surface of the normal-metal thin film.<sup>20,21</sup> ZBCPs of this kind usually increase immediately below  $T_c$ . The ZBCP observed here seems irrelevant to this mechanism, since it has sensitive T and B dependencies, appearing at much lower temperatures.

The second possible mechanism is related to coherent scattering of carriers near the interface due to a phase conjugation between the electron's and the hole's trajectories, leading to an enhanced AR probability.<sup>25</sup> This mechanism is also expressed in a more general way by using a random matrix theory.<sup>26</sup> A ZBCP caused by this mechanism is sensitive to both temperature and magnetic field, since it involves a coherent loop. However, these theories do not take account of the strong SOC and its resulting Berry phase. In the presence of strong SOC, the phase accumulated by the incident electron along its path cannot be canceled by the retroreflected hole, i.e., the phase difference between the Nth and the (N + 1)th reflected hole is not zero. Furthermore, the theory in Ref. 26 suggests that this kind of ZBCP often appears in junctions with a relatively strong scattering rate, and that the value of the conductance peak will not exceed the conductance of the normal state, whereas in our experiment the ZBCP can be higher than the conductance of the normal state, as shown in Fig. 1(a) for device #2. Therefore, we believe that the ZBCP observed in our experiments is not caused by the aforementioned constructive interference.

The third explanation is to phenomenologically attribute ZBCP to a pair current flowing between the superconducting electrode and the proximity-induced superconducting phase.<sup>19</sup> For a ZBCP of this type, its behavior will resemble the critical supercurrent of a Josephson junction. As the temperature

decreases, the critical current of a Josephson junction will first increase and then get saturated. For a ZBCP of this type, therefore, its peak width is expected to increase with decreasing T if it is plotted against bias current. However, the ZBCP in this experiment shrinks with decreasing T, as can be seen in Fig. 5. Therefore, the pair current picture seems inapplicable to our results.

Another possible mechanism of ZBCP involves unconventional superconductivity with an asymmetric orbital order parameter.<sup>27–34</sup> For example, in the *p*-wave superconductor  $Sr_2RuO_4$ , the reflection of order parameter at the S-N edge in the *ab* plane undergoes a sign change, giving rise to an Andreev bound state at the Fermi energy and a ZBCP in tunneling measurement.<sup>27</sup> After having ruled out other possible mechanisms, to the best of our knowledge, we believe that this mechanism involving unconventional superconductivity is most likely responsible for the appearance of the ZBCP in this experiment.

Our entire picture for the observed phenomena is as follows. With decreasing T to below  $T_c$  of Sn, the proximity effect develops at the S-N interface via two-particle exchange processes, i.e., Cooper pairs are exchanged from the Sn side to the Bi2Se3 side, and entangled quasiparticle pairs are exchanged back in a time-reversal process, known as AR. Unlike in an usual proximity effect, where only a single gap of the parent superconductor is seen, the observation of a second gap here indicates the formation of a different S'-N interface where S' is not Sn but a proximity-effect-induced superconducting  $Bi_2Se_3$  phase. The original  $Sn-Bi_2Se_3$ interface becomes an S-S' interface whose role vanishes in resistance measurement, so that the gap structure related to Sn is either absent or largely suppressed. We speculate that the suppression of backscattering due to strong SOC and the high electron mobility in Bi<sub>2</sub>Se<sub>3</sub> would help maintaining the coherence of the two-particle AR process in space and time domains, thus stabilizing the proximity-effect-induced superconducting phase (S' phase) in a substantially large volume of Bi<sub>2</sub>Se<sub>3</sub>.

With further decreasing T, the induced superconducting phase becomes uniformly developed, and then the coherence peaks appear at the two shoulders of the gap. The ZBCP increases simultaneously, which is presumably also related to the improved uniformity of this superconducting phase at low temperatures.

Since no ZBCP is observed in similar devices made of graphite which has negligible SOC, one would naturally speculate that strong SOC is the cause for generating the ZBCP in Sn-Bi<sub>2</sub>Se<sub>3</sub> devices. The important role of strong SOC in the electron states in Bi<sub>2</sub>Se<sub>3</sub> has been revealed by the unusually robust behavior of the electron's weak antilocalization,<sup>10–14</sup> a phenomenon which mainly occurs in two-dimensional (2D) electron systems. It indicates the existence of a Berry phase  $\pi$ in the electrons' band structure. The induced superconducting phase inhabited in such a background, with an interlocked momentum and spin degrees of freedom, is believed to own effectively a spinless  $p_x + ip_y$  pairing symmetry. The asymmetric orbital part of the order parameter, inherited from the Berry curvature of the bands, forms resonant bound states at the S'-N interface due to the interference between the incoming and reflecting wave forms there, hence giving rise to the observed ZBCP. With such a picture, it is natural that the peak width gets narrower with reduced thermal broadening at lower T.

### V. CONCLUSION

To summarize, we have investigated the conductance spectra of S-N junctions between an s-wave superconductor Sn and a strong SOC material, Bi<sub>2</sub>Se<sub>3</sub>. A small gap that is different from that of Sn was clearly resolved, together with a ZBCP that increases at low temperatures. The results indicate the formation of a different superconducting phase with unconventional pairing symmetry at the interface. Our work may encourage future experiments to search for Majorana fermions and other pertinent properties by employing hybrid structures of s-wave superconductor and topological insulatorrelated materials. *Note added*: After the submission of this manuscript and posted on arXiv (arXiv:1105.0229v1), the observation of a supercurrent and possible evidence of Pearl vortices were reported in a W-Bi<sub>2</sub>Se<sub>3</sub>-W junction,<sup>35</sup> a ZBCP was observed on a normal metal-Cu<sub>x</sub>Bi<sub>2</sub>Se<sub>3</sub> point contact,<sup>36</sup> and evidence of perfect Andreev reflection of the helical mode was obtained in InAs/GaSb quantum wells.<sup>37</sup>

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